

#### Positive Fixed 12V Voltage Regulator in bare die form

Rev 1.0 19/04/19

#### Description

The 7812AC 12V fixed 3-terminal positive voltage regulator delivers up to 1.5A of output current with adequate heat-sinking. The device is equipped with internal limiting, safe-area compensation + thermal shutdown features for overload immunity. The 7812AC can be used with external components to obtain adjustable voltages or currents & can also be used as the power-pass element in precision high-current voltage regulators. No external components are needed other than to enhance performance or increase design flexibility.

#### **Ordering Information**

The following part suffixes apply:

- No suffix MIL-STD-883 /2010B Visual Inspection.
- "H" MIL-STD-883 /2010B Visual Inspection
  + MIL-PRF-38534 Class H LAT
- "K" MIL-STD-883 /2010A Visual Inspection (Space)
  + MIL-PRF-38534 Class K\_AT

LAT = Lot Acceptance Test.

For further information on LAT places flows see below.

www.siliconsupplies.com\quality\bare-die-lot-qualification

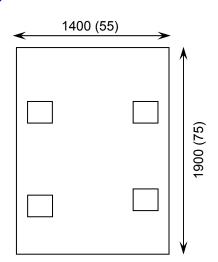
#### Supply Formats:

- Defaut Die in Waffle Pack (100 per tray capacity)
- Sawn Wafer on Tape On request
- Unsawn Wafer On request
- Tape & Reel On request
- In Metal or Ceramic package On request

#### Features:

- ±2% V<sub>OUT</sub> tolerance at 25°C
- Greater than 1A output current capability
- Internal thermal overload processing
- Internal short-circuit current imit
- Output capacitor not essential for stability
- Full Military temperature range
- Negative oltage complement is 7912AC

#### Die Qin ensions in µm (mils)



#### **Mechanical Specification**

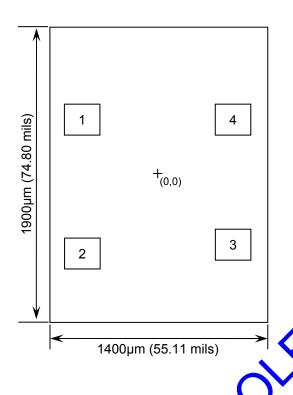
Die Size (Unsawn)	1400 x1900 55 x 75	μm mils	
Minimum Bond Pad Size	230 x 230 9.05 x 9.05	μm mils μm mils	
Die Thickness	280 (±20) 11.02 (±0.79)		
Top Metal Composition	Al 1%Si 1.1μm		
Back Metal Composition	Ti/Ni/Ag 1.2 μm		





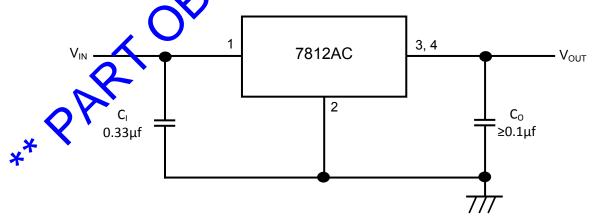
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#### Pad Layout and Functions



			<u> </u>		
PAD	FUNCTION	COORDINATES (µI			
FAD TONCTI	1 ONO HON	X	Y		
1	V <sub>IN</sub>	-610	247		
2	GNV	-610	-626		
3	V <sub>OU</sub>	372	-560		
4	V <sub>OUT</sub>	372	247		
CONNECT CHIP BACK TO GND					

Typical Application



 $C_{\rm l}$  is required if the regulator is located an appreciable distance from power supply filter.  $C_{\rm O}$  is not required for stability; however it does improve transient response. For optimum stability and transient response locate  $C_{\rm l}$   $C_{\rm O}$  as close as possible to the regulator. A common ground is required between the input and the output voltages. The input voltage must remain typically 2.0 V above the output voltage even during the low point on the input ripple voltage.





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### Absolute Maximum Ratings<sup>1</sup>

PARAMETER	SYMBOL	VALUE	UNYI		
Input Voltage	V <sub>IN</sub>	36	V		
Power Dissipation <sup>2</sup>	P <sub>D</sub>	Internally Limited	V		
Operating Temperature Range	-	-55 to 150	°C		
Maximum Junction Temperature	T <sub>J</sub>	150	°C		
Storage Temperature	T <sub>STG</sub>	-65 to 150	°C		

### **Recommended Operating Conditions**

PARAMETER	SYMBOL	MIN	MAX	UNIT
Input Voltage	V <sub>IN</sub>	7	25	V
Output Current	I <sub>out</sub>		1.5	Α
Operating Temperature Range	T <sub>J</sub>	-5 j	125	°C

### DC Electrical Characteristics, V<sub>I</sub> =19V, I<sub>OUT</sub>=500mA,C<sub>I</sub>=0.33μ), C<sub>O</sub>=0.1μf, T<sub>MIN</sub>≤T<sub>J</sub>≤T<sub>MAX</sub>(unless noted otherwise)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Output Voltage	V <sub>OUT</sub>	I <sub>OUT</sub> = 1A, T <sub>J</sub> <mark>= 25</mark> °C	11.75	12	12.25	V
		$5\text{mA} \le I_{\text{QUT}} \le 1\text{A},$ $14.8\text{V} \le V_{\text{IN}} \le 27\text{V}, P_{\text{D}} \le 15 \text{ Watts}$	11.5	12	12.5	
		14.2V ≤ V <sub>1</sub> ≤ 30V	-	3.8	18	
Line Regulation	$\Delta V_{OUT}$	16V∠V <sub>IN</sub> ≤22V, I <sub>OUT</sub> = 1A	-	2.2	20	
		14.5V ≤ V <sub>M</sub> ≤ 27V,I <sub>OUT</sub> =1A,T <sub>J</sub> = 25°C	-	6.0	120	mV
Load Regulation	ΔV <sub>OUT</sub>	$500 \le 1_{OUT} \le 1.5A, T_J = 25^{\circ}C$	-	-	25	
Load Negalation	<b>A V</b> OUT	5mA ≤ I <sub>OUT</sub> ≤ 1A	-	-	25	
Input Bias Current	I <sub>B</sub>	I <sub>OUT</sub> = 1A	-	3.4	6.0	mA
Input Bias Current	Δl <sub>B</sub>	15V≤ V <sub>IN</sub> ≤ 30V	-	-	0.8	mA
Change		14.8V≤ V <sub>IN</sub> ≤ 27V, I <sub>OUT</sub> =1A,T <sub>J</sub> = 25°C	-	-	0.8	
5.14.1.95		5mA ≤ I <sub>OUT</sub> ≤ 1A, T <sub>J</sub> = 25°C	-	-	0.5	
Output Noise Voltage	V <sub>n</sub>	10Hz ≤ f ≤ 100KHz, T <sub>J</sub> = 25°C	-	10	-	μV/V <sub>OUT</sub>
Ripple Rejection	RR	15V ≤ V <sub>IN</sub> ≤ 25V, f = 120Hz	55	60	-	dB
Dropout Voltage	V <sub>IN</sub> – V <sub>OUT</sub>	I <sub>OUT</sub> = 1A, T <sub>J</sub> = 25°C	-	2	-	V
Output Resistance	r <sub>OUT</sub>	f = 1 kHz	-	1.1	-	mΩ
Short-Circuit Current Limit	I <sub>SC</sub>	V <sub>IN</sub> = 35V, T <sub>A</sub> = 25°C	-	0.2	-	Α
Peak Output Current	I <sub>MAX</sub>	T <sub>J</sub> = 25°C	-	2.2	-	Α
Avg. Output Voltage Temp. Coefficient	TCV <sub>OUT</sub>		-	-0.8	-	mV/°C

<sup>1.</sup> Operation above the absolute maximum rating may cause device failure. Operation at the absolute maximum ratings, for extended periods, may reduce device reliability. 2. Results in die form are dependent on die attach and assembly method. Max power dissipation is internally limited by the die.





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### **Typical Characteristics**

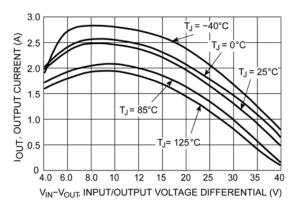


Figure 1 – Peak output current as a function of input/output differential voltage

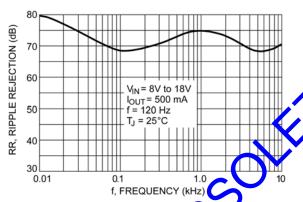


Figure 3 – Ripple rejection as a function of frequency

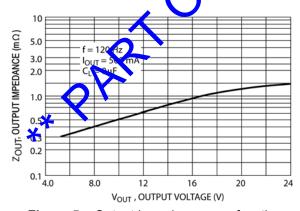


Figure 5 – Output impedance as a function of output Voltage

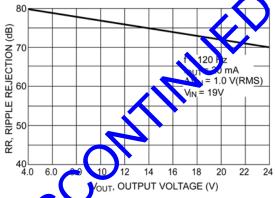


Figure 2 – Ripple rejection as a function of output voltage

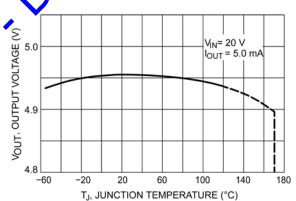


Figure 4 – Output voltage as a function of junction temperature

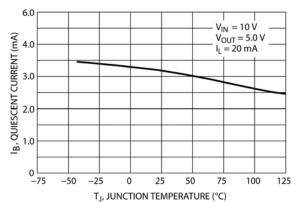


Figure 6 – Quiescent current as a function of temperature





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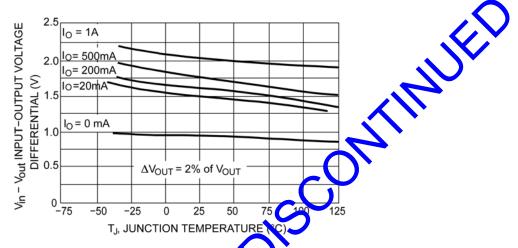


Figure 7 – Input/Output differential voltage as a function of junction temperature



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